

**FET BIAS CONTROLLER WITH POLARISATION
SWITCH AND TONE DETECTION**
ISSUE 1 - OCTOBER 1998

**ZN BG3113
ZN BG3114**

DEVICE DESCRIPTION

The ZN BG series of devices are designed to meet the bias requirements of GaAs and HEMT FETs commonly used in satellite receiver LNBs, PMR cellular telephones etc. with a minimum of external components.

With the addition of two capacitors and a resistor the devices provide drain voltage and current control for three external grounded source FETs, generating the regulated negative rail required for FET gate biasing whilst operating from a single supply. This negative bias, at -3 volts, can also be used to supply other external circuits.

The ZN BG3113/14 includes bias circuits to drive up to three external FETs. A control input to the device selects either one of two FETs as operational, the third FET is permanently active. This feature is particularly used as an LNB polarisation switch. Also specific to LNB applications is the 22kHz tone detection and logic output feature which is used to enable high and low band frequency switching.

The facility to control the tone switching delay is provided. This allows the rejection of other lower frequency tones that may be present in multiple LNB applications.

Drain current setting of the ZN BG3113/14 is user selectable over the range 0 to 15mA, this is achieved with addition of a single resistor. The series also offers the choice of drain voltage to be set for the FETs, the 3113 gives 2.2 volts drain whilst the 3114 gives 2 volts.

These devices are unconditionally stable over the full working temperature with the FETs in place, subject to the inclusion of the recommended gate and drain capacitors. These ensure RF stability and minimal injected noise.

It is possible to use less than the devices full complement of FET bias controls, unused drain and gate connections can be left open circuit without affecting operation of the remaining bias circuits.

To protect the external FETs the circuits have been designed to ensure that, under any conditions including power up/down transients, the gate drive from the bias circuits cannot exceed the range -3.5V to 1V. Furthermore if the negative rail experiences a fault condition, such as overload or short circuit, the drain supply to the FETs will shut down avoiding excessive current flow.

The ZN BG3113/14 are available in QSOP20 for the minimum in device size. Device operating temperature is -40 to 70°C to suit a wide range of environmental conditions.

FEATURES

- Provides bias for GaAs and HEMT FETs
- Drives up to three FETs
- Dynamic FET protection
- Drain current set by external resistor
- Regulated negative rail generator requires only 2 external capacitors
- Choice in drain voltage
- Wide supply voltage range
- Polarisation switch for LNBs
- 22KHz tone detection for band switching
- Programmable tone delay
- Compliant with ASTRA control specifications
- QSOP surface mount package

APPLICATIONS

- Satellite receiver LNBs
- Private mobile radio (PMR)
- Cellular telephones

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ABSOLUTE MAXIMUM RATINGS

Supply Voltage	-0.6V to 12V	Power Dissipation (T_{amb}= 25°C)		
Supply Current	100mA	QSOP20		
Input Voltage (V _{POL})	25V Continuous	500mW		
Drain Current (per FET) (set by R _{CAL})	0 to 15mA			
Operating Temperature	-40 to 70°C			
Storage Temperature	-50 to 85°C			

ELECTRICAL CHARACTERISTICS. TEST CONDITIONS
(Unless otherwise stated): T_{amb}= 25°C, V_{CC}=5V, I_D=10mA (R_{CAL}=33kΩ)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	
V _{CC}	Supply Voltage		5		10	V
I _{CC}	Supply Current	I _{D1} to I _{D3} =0 I _{D1} =0, I _{D2} to I _{D3} =10mA, V _{POL} =14V I _{D2} =0, I _{D1} to I _{D3} =10mA, V _{POL} =15.5V I _{D1} to I _{D3} =0, I _{LB} =10mA I _{D1} to I _{D3} =0, I _{HB} =10mA			15 35 35 45 45	mA mA mA mA mA
V _{SUB}	Substrate Voltage	(Internally generated) I _{SUB} =0 I _{SUB} =-200μA	-3.5	-3.0 -2.4	-2.5 -2.4	V V
E _{ND} E _{NG}	Output Noise Drain Voltage Gate Voltage	C _G =4.7nF, C _D =10nF C _G =4.7nF, C _D =10nF			0.02 0.005	Vpkpk Vpkpk
f ₀	Oscillator Frequency		200	350	800	kHz

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SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	

GATE CHARACTERISTICS

I_{GO}	Output Current Range		-30		2000	μA
		I_{Dx} (mA) V_{POL} (V) I_{GOx} (μA)				
V_{G10}	Output Voltage Gate 1	$I_{D1}=0$ $V_{POL}=14$ $I_{GO1}=-10$	-2.7	-2.4	-2.0	V
V_{G1L}	Off	$I_{D1}=12$ $V_{POL}=15.5$ $I_{GO1}=-10$	-2.7	-2.4	-2.0	V
V_{G1H}	Low	$I_{D1}=8$ $V_{POL}=15.5$ $I_{GO1}=0$	0.4	0.75	1.0	V
V_{G20}	Output Voltage Gate 2	$I_{D2}=0$ $V_{POL}=15.5$ $I_{GO2}=-10$	-2.7	-2.4	-2.0	V
V_{G2L}	Off	$I_{D2}=12$ $V_{POL}=14$ $I_{GO2}=-10$	-2.7	-2.4	-2.0	V
V_{G2H}	High	$I_{D2}=8$ $V_{POL}=14$ $I_{GO2}=0$	0.4	0.75	1.0	V
V_{G3L}	Output Voltage Gate 3	$I_{D3}=12$ $I_{GO3}=-10$	-3.5	-2.9	-2.0	V
V_{G3H}	Low	$I_{D3}=8$ $I_{GO3}=0$	0.4	0.75	1.0	V

DRAIN CHARACTERISTICS

I_D	Current		8	10	12	mA
ΔI_{DV} ΔI_{DT}	Current Change with V_{CC} with T_j	$V_{CC}=5$ to 10V $T_j=-40$ to $+70^\circ C$		0.2 0.05		%/V %/°C
V_{D1}	Drain 1 Voltage: High ZN BG3113 ZN BG3114	$I_{D1}=10mA$, $V_{POL}=15.5V$ $I_{D1}=10mA$, $V_{POL}=15.5V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
V_{D2}	Drain 2 Voltage: High ZN BG3113 ZN BG3114	$I_{D2}=10mA$, $V_{POL}=14V$ $I_{D2}=10mA$, $V_{POL}=14V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
V_{D3}	Drain 3 Voltage: High ZN BG3113 ZN BG3114	$I_{D3}=10mA$, $V_{POL}=15.5V$ $I_{D3}=10mA$, $V_{POL}=15.5V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
ΔV_{DV} ΔV_{DT}	Voltage Change with V_{CC} with T_j	$V_{CC}=5$ to 10V $T_j=-40$ to $+70^\circ C$		0.5 50		%/V ppm
I_{L1} I_{L2}	Leakage Current Drain 1 Drain 2	$V_{D1}=0.1V$, $V_{POL}=14V$ $V_{D2}=0.1V$, $V_{POL}=15.5V$			10 10	μA μA

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SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNITS
			MIN.	TYP.	

TONE DETECTION CHARACTERISTICS

I_B	Filter Amplifier Input Bias Current	$R_{F1}=150\text{k}\Omega$	0.04	0.15	1.0	μA
V_{OUT}	Output Voltage ⁵	$R_{F1}=150\text{k}\Omega$	1.75	1.95	2.05	V
I_{OUT}	Output Current ⁵	$V_{OUT}=1.96\text{V}$, $V_{FIN}=2.1\text{V}$	400	520	650	μA
G_V	Voltage Gain	$f=22\text{kHz}$, $V_{IN}=1\text{mV}$		46		dB
V_{OUT}	Rectifier Output Voltage ⁵	$R_{F1}=150\text{k}\Omega$ $I_L=-10\mu\text{A}$	1.8	2.0	2.2	V
I_{LEAK}	Leakage Current ⁵	$R_{F1}=150\text{k}\Omega$ $V_{OUT}=3\text{V}$		20	200	nA
V_{TH}	Comparator Threshold Voltage ⁵	$f=0$	2.95	3.2	3.45	V
V_{LOV}	Output Stage Low Volt. Range	$I_L=50\text{mA}$ (L_B or H_B)	-0.5		$V_{CC}-1.8$	V
I_{LOV}	Low Bias Current	$V_{LOV}=0$	0.04	0.15	1.0	μA
V_{LBL}	L_B Output Low	$V_{LOV}=0$ $I_L=-10\mu\text{A}$ Enabled ⁶ $V_{LOV}=3\text{V}$ $I_L=0$ Enabled ⁷	-3.5 -0.01	-2.75 0	-2.5 0.01	V V
V_{LBH}	L_B Output High	$V_{LOV}=0$ $I_L=10\text{mA}$ Disabled ⁶ $V_{LOV}=3\text{V}$ $I_L=50\text{mA}$ Disabled ⁷	-0.025 2.9	0 3.0	0.025 3.1	V V
V_{HBL}	H_B Output Low	$V_{LOV}=0$ $I_L=-10\mu\text{A}$ Enabled ⁶ $V_{LOV}=3\text{V}$ $I_L=0$ Enabled ⁷	-3.5 -0.01	-2.75 0	-2.5 0.01	V V
V_{HBH}	H_B Output High	$V_{LOV}=0$ $I_L=10\text{mA}$ Disabled ⁶ $V_{LOV}=3\text{V}$ $I_L=50\text{mA}$ Disabled ⁷	-0.025 2.9	0 3.0	0.025 3.1	V V

POLARITY SWITCH CHARACTERISTICS

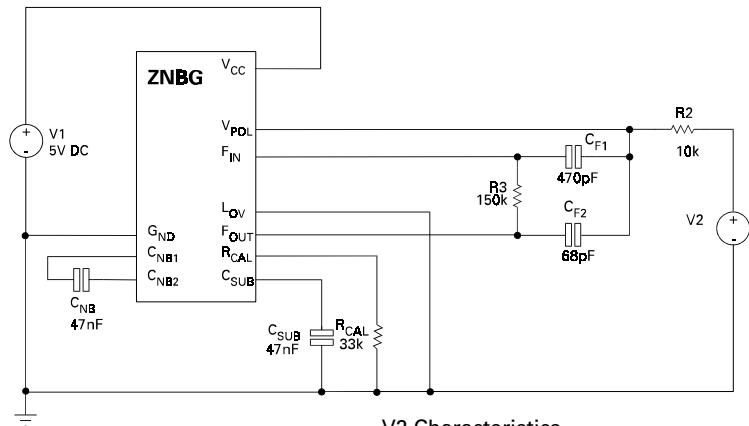
I_{POL}	Input Current	$V_{POL}=25\text{V}$ (Applied via $R_{POL}=10\text{k}\Omega$)	10	20	40	μA
V_{TPOL}	Threshold Voltage	$V_{POL}=25\text{V}$ (Applied via $R_{POL}=10\text{k}\Omega$)	14	14.75	15.5	V
T_{SPOL}	Switching Speed	$V_{POL}=25\text{V}$ (Applied via $R_{POL}=10\text{k}\Omega$)			100	ms

NOTES:

1. The negative bias voltages specified are generated on-chip using an internal oscillator. Two external capacitors, C_{NB} and C_{SUB} , of 47nF are required for this purpose.
2. The characteristics are measured using an external reference resistor R_{CAL} of value 33k wired from pins R_{CAL} to ground.
3. Noise voltage is not measured in production.
4. Noise voltage measurement is made with FETs and gate and drain capacitors in place on all outputs. C_G , 4.7nF , are connected between gate outputs and ground, C_D , 10nF , are connected between drain outputs and ground.
5. These parameters are linearly related to V_{CC} .
6. These parameters are measured using Test Circuit 1
7. These parameters are measured using Test Circuit 2

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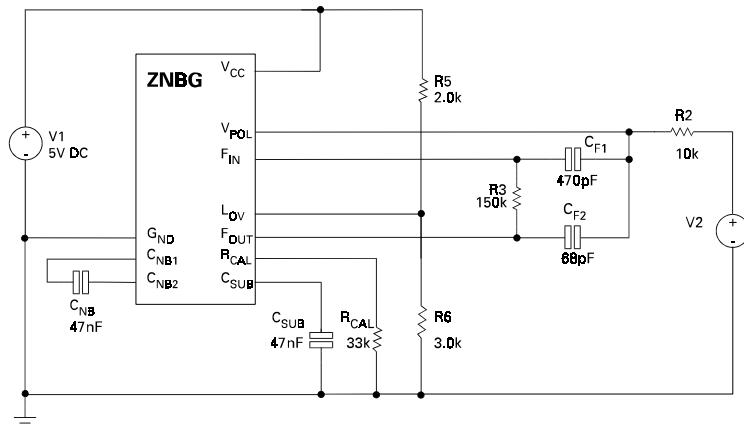
TEST CIRCUIT 1



V2 Characteristics

Type	AC source
Frequency	22kHz
Voltage	350mV p/p enabled 100mV p/p disabled

TEST CIRCUIT 2

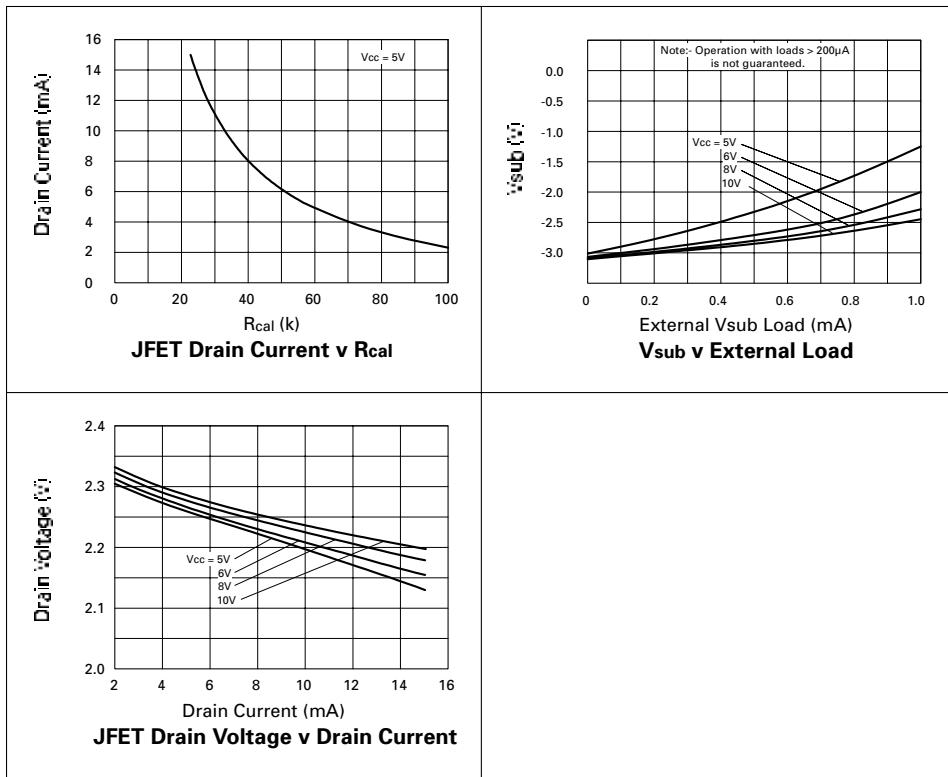


V2 Characteristics

Type	AC source
Frequency	22kHz
Voltage	350mV p/p enabled 100mV p/p disabled

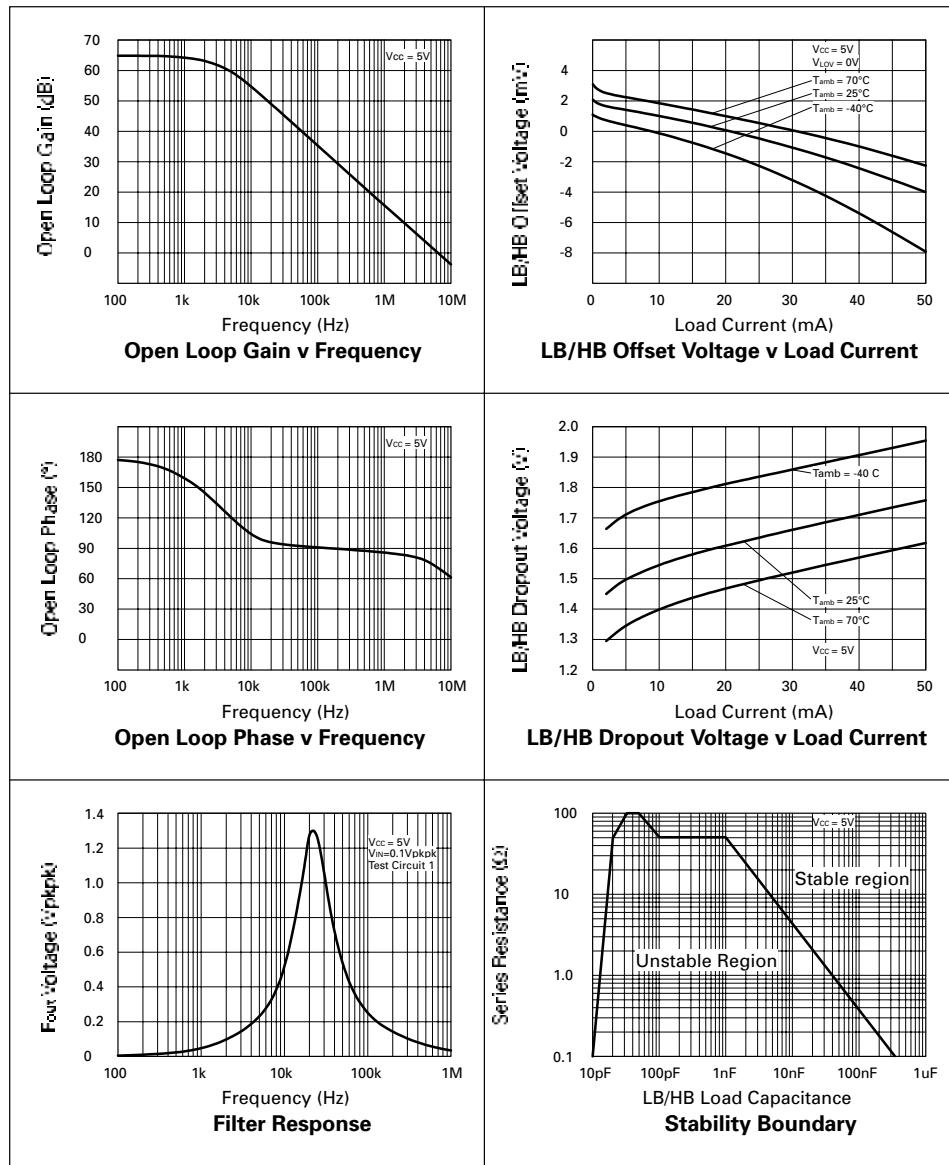
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TYPICAL CHARACTERISTICS



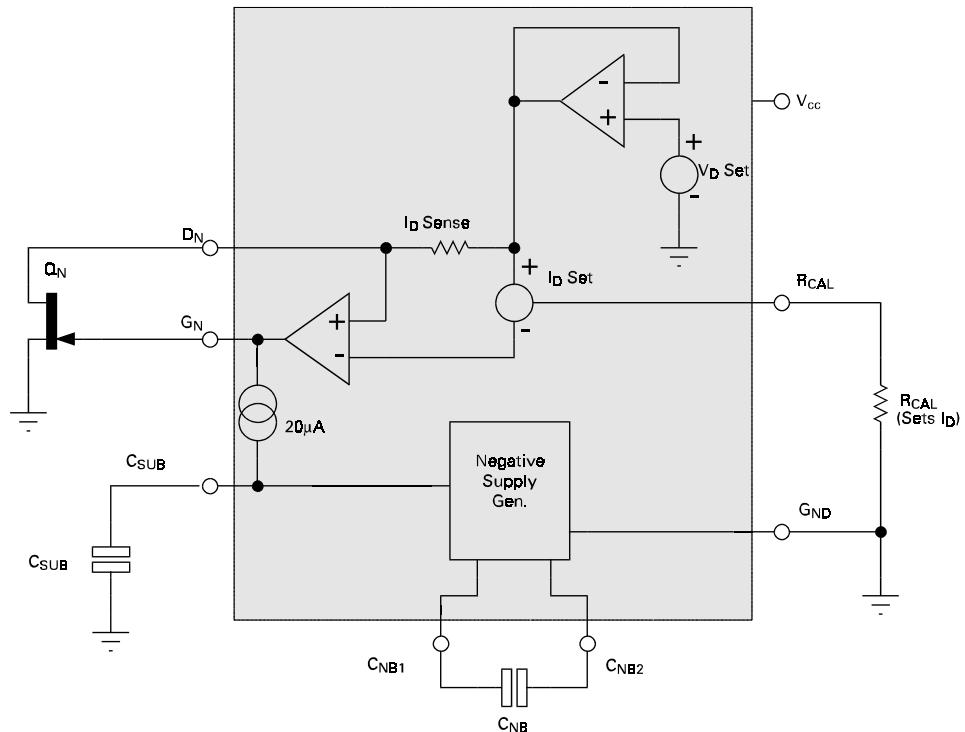
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TYPICAL CHARACTERISTICS



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FUNCTIONAL DIAGRAM



FUNCTIONAL DESCRIPTION

The ZNBG devices provide all the bias requirements for external FETs, including the generation of the negative supply required for gate biasing, from the single supply voltage. The diagram above shows a single stage from the ZNBG series. The ZNBG3113/14 contains 3 such stages. The negative rail generator is common to both devices.

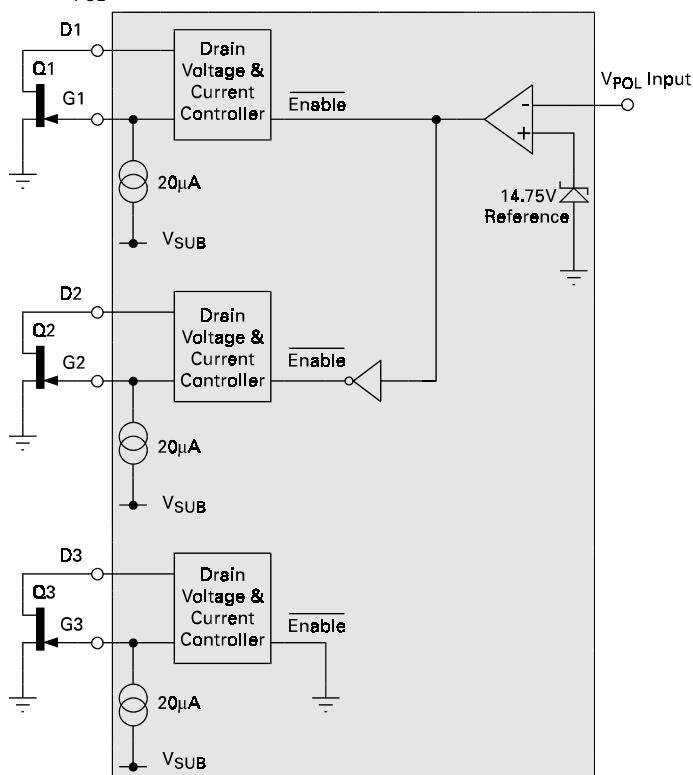
The drain voltage of the external FET Q_N is set by the ZNBG device to its normal operating voltage. This is determined by the on board V_D Set reference, for the ZNBG3113 this is nominally 2.2 volts whilst the ZNBG3114 provides nominally 2 volts.

The drain current taken by the FET is monitored by the low value resistor ID Sense. The amplifier driving the gate of the FET adjusts the gate voltage of Q_N so that the drain current taken matches the current called for by an external resistor R_{CAL} .

Since the FET is a depletion mode transistor, it is often necessary to drive its gate negative with respect to ground to obtain the required drain current. To provide this capability powered from a single positive supply, the device includes a low current negative supply generator. This generator uses an internal oscillator and two external capacitors, C_{NB} and C_{SUB} .

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The following schematic shows the function of the V_{POL} input. Only one of the two external FETs numbered Q1 and Q2 are powered at any one time, their selection is controlled by the input V_{POL} . This input is designed to be wired to the power input of the LNB via a high value (10k) resistor. With the input voltage of the LNB set at or below 14V, FET Q2 will be enabled. With the input voltage at or above 15.5V, FET Q1 will be enabled. The disabled FET has its gate driven low and its drain terminal is switched open circuit. It is permissible to connect the drain pins D1 and D2 together if required by the application circuit. FET number Q3 is always active regardless of the voltage applied to V_{POL} .



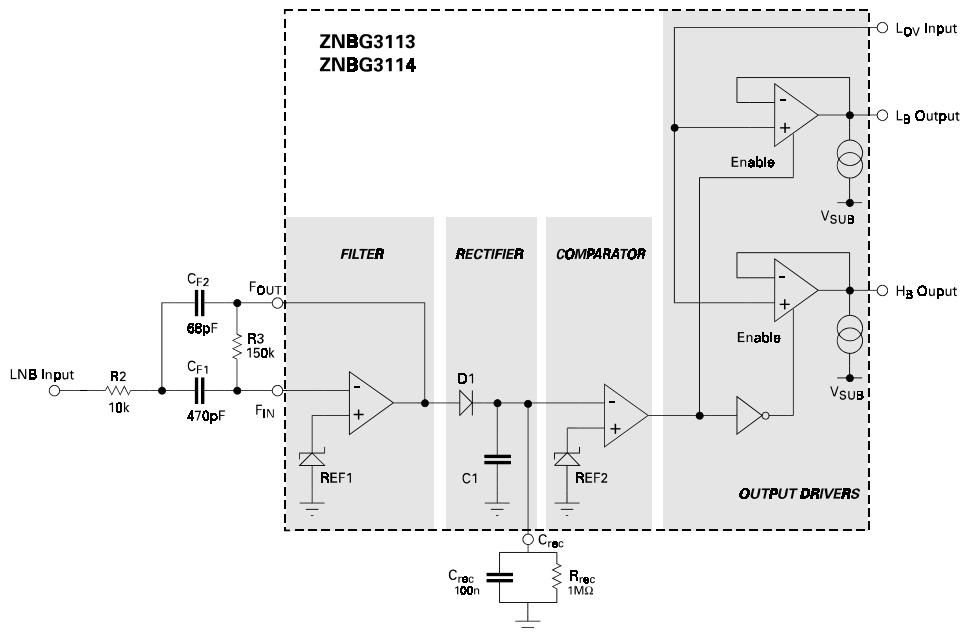
Control Input Switch Function

Input Sense	Polarisation	Select
≤ 14 volts	Vertical	FET Q2
≥ 15.5 volts	Horizontal	FET Q1

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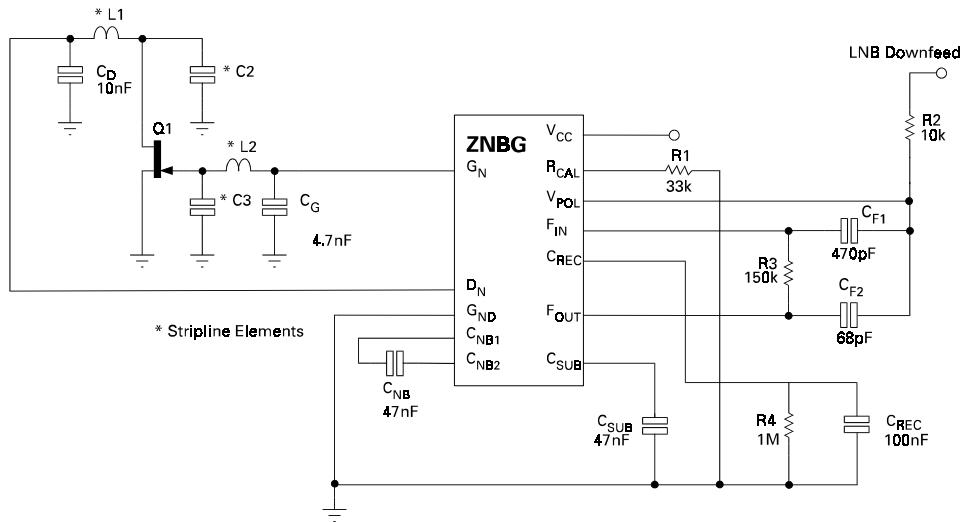
For many LNB applications tone detection and band switching is required. The ZNBG3113/14 includes the circuitry necessary to detect the presence of a 22kHz tone modulated on the supply input to the LNB. Referring to the following schematic diagram, the main elements of this detector are an op-amp enabling the construction of a Sallen Key filter, a rectifier/smoothed and a comparator. Full control is given over the centre frequency and bandwidth of the filter by the selection of two external resistors and capacitors (one of these resistors, R2, shares the function of overvoltage protection of pin V_{POL}).

Pin C_{rec} makes accessible the output of the tone switch rectifier and provides a means of controlling tone switch delays (mainly HB-LB). For correct operation of the IC, a capacitor and a parallel connected resistor should be connected between this pin and ground. A capacitor of 100nF and resistor of 1MW will give a LB-HB delay of around 100 μ s and a HB-LB delay of 30ms. The comparator circuit utilises no external components.



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APPLICATIONS CIRCUIT



APPLICATIONS INFORMATION

The above is a partial application circuit for the ZNBG series showing all external components required for appropriate biasing. The bias circuits are unconditionally stable over the full temperature range with the associated FETs and gate and drain capacitors in circuit.

Capacitors C_D and C_G ensure that residual power supply and substrate generator noise is not allowed to affect other external circuits which may be sensitive to RF interference. They also serve to suppress any potential RF feedthrough between stages via the ZNBG device. These capacitors are required for all stages used. Values of 10nF and 4.7nF respectively are recommended however this is design dependent and any value between 1nF and 100nF could be used.

The capacitors C_{NB} and C_{SUB} are an integral part of the ZNBGs negative supply generator. The negative bias voltage is generated on-chip using an internal oscillator. The required value of capacitors C_{NB} and C_{SUB} is 47nF. This generator produces a low current supply of approximately -3 volts. Although this generator is intended purely to bias the external FETs, it can be used to power other external circuits via the C_{SUB} pin.

Resistor R_{CAL} sets the drain current at which all external FETs are operated. If any bias control circuit is not required, its related drain and gate connections may be left open circuit without affecting the operation of the remaining bias circuits.

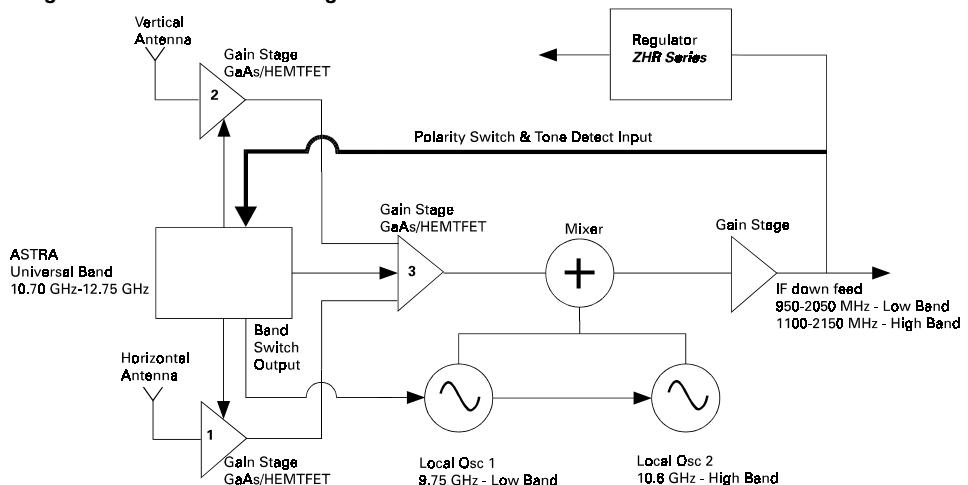
The ZNBG devices have been designed to protect the external FETs from adverse operating conditions. With a JFET connected to any bias circuit, the gate output voltage of the bias circuit can not exceed the range -3.5V to 1V under any conditions, including powerup and powerdown transients. Should the negative bias generator be shorted or overloaded so that the drain current of the external FETs can no longer be controlled, the drain supply to FETs is shut down to avoid damage to the FETs by excessive drain current.

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APPLICATIONS INFORMATION(cont)

The following block diagram shows the main section of an LNB designed for use with the Astra series of satellites. The ZNBG3113/14 is the core bias and control element of this circuit. The ZNBG provides the negative rail, FET bias control, polarisation switch control, tone detection and band switching with the minimum of external components. Compared to other discrete component solutions the ZNBG circuit reduces component count and overall size required.

Single Universal LNB Block Diagram



Tone detection and band switching is provided on the ZNBG3113/14 devices. The following diagrams describes how this feature operates in an LNB and the external components required. The presence or absence of a 22kHz tone applied to pin F_{IN} enables one of two outputs, L_B and H_B . A tone present enables H_B and tone absent enables L_B . The L_B and H_B outputs are designed to be compatible with both MMIC and discrete local oscillator applications, selected by pin L_{OV} . Referring to Figure 1 wiring pin L_{OV} to ground will force L_B and H_B to switch between -2.6V (disabled) and 0V (enabled). Referring to Figure 2 wiring pin L_{OV} to a positive voltage source (e.g. a potential divider across V_{CC} and ground set to the required oscillator supply voltage, V_{OSC}) will force the L_B and H_B outputs to provide the required oscillator supply, V_{OSC} , when enabled.

Tone Detection Function

L_{OV}	F_{IN}	L_B	H_B	L_B	H_B
G_{ND}	22kHz	Disabled	Enabled	-2.6 volts	G_{ND}
	—	Enabled	Disabled	G_{ND}	-2.6 volts
V_{OSC}	22kHz	Disabled	Enabled	Note 1	V_{OSC}
	—	Enabled	Disabled	V_{OSC}	Note 1

Note 1: 0 volts in typical LNB applications but dependent on external circuits.

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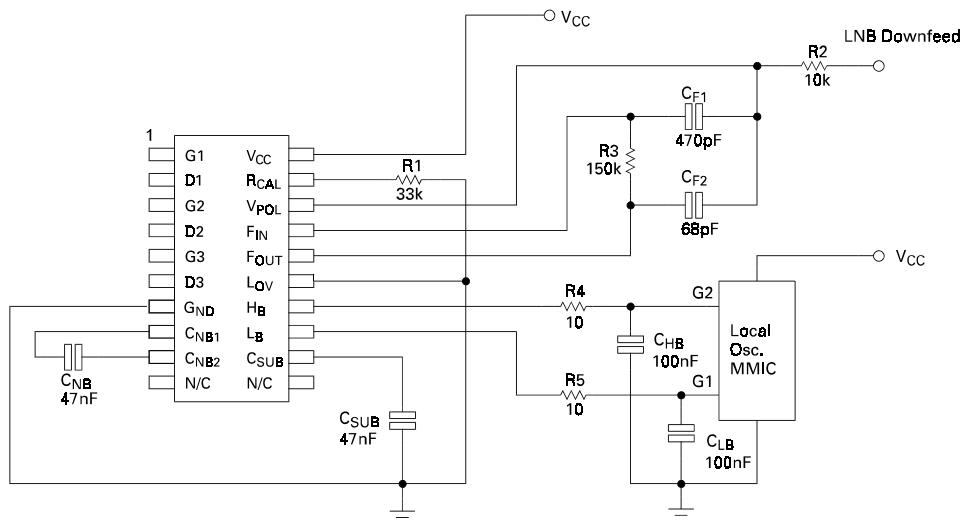


Figure 1
Lov grounded

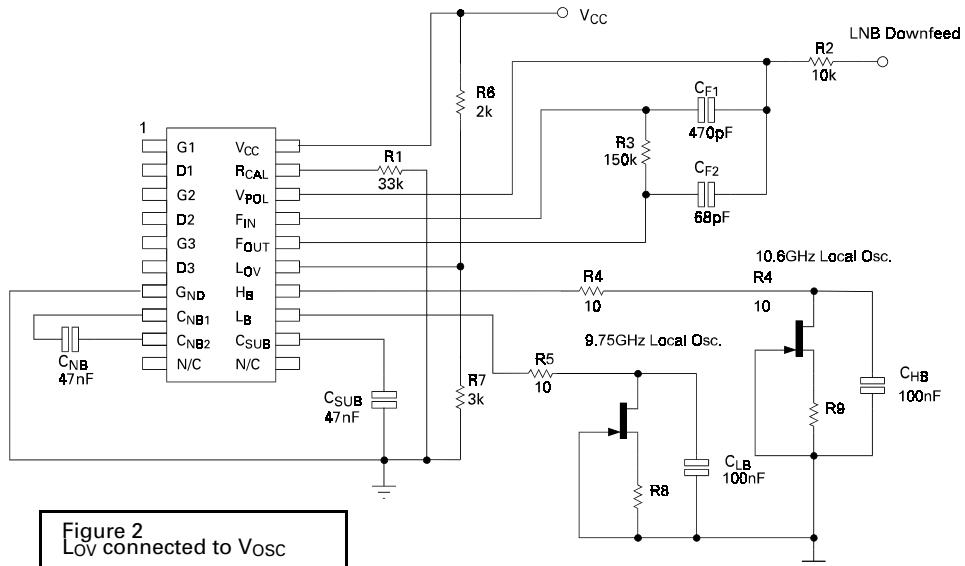
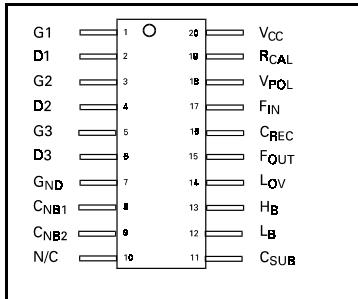


Figure 2
L_{ov} connected to V_{osc}

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CONNECTION DIAGRAM

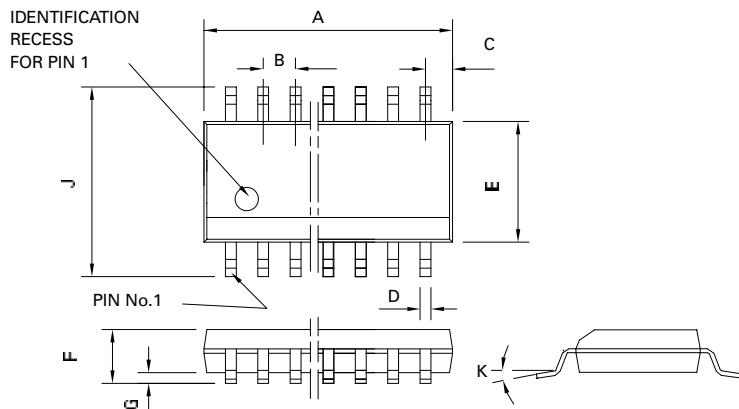


ORDERING INFORMATION

Part Number	Package	Part Mark
ZNBG3113Q20	QSOP20	ZNBG3113
ZNBG3114Q20	QSOP20	ZNBG3114

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PACKAGE DIMENSIONS



PIN	Millimetres		Inches	
	MIN	MAX	MIN	MAX
A	8.55	8.74	0.337	0.344
B	0.635		0.025 NOM	
C	1.42	1.52	0.056	0.06
D	0.20	0.30	0.008	0.012
E	3.81	3.99	0.15	0.157
F	1.35	1.75	0.053	0.069
G	0.10	0.25	0.004	0.01
J	5.79	6.20	0.228	0.244
K	0°	8°	0°	8°

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